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# BLF6G27L-50BN

Power LDMOS transistor

Rev. 4 — 1 September 2015

AMPLEON

Product data sheet

## 1. Product profile

### 1.1 General description

50 W LDMOS power transistor for base station applications at frequencies from 2500 MHz to 2700 MHz.

**Table 1. Typical performance**

*RF performance at  $T_{case} = 25\text{ °C}$  in a common source class-AB production test circuit.*

| Test signal      | f<br>(MHz)   | $I_{DQ}$<br>(mA) | $V_{DS}$<br>(V) | $P_{L(AV)}$<br>(W) | $G_p$<br>(dB) | $\eta_D$<br>(%) | ACPR<br>(dBc)           |
|------------------|--------------|------------------|-----------------|--------------------|---------------|-----------------|-------------------------|
| 2-carrier W-CDMA | 2500 to 2700 | 430              | 28              | 3                  | 16.5          | 14.5            | -47 <a href="#">[1]</a> |

[1] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz

### 1.2 Features and benefits

- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (2500 MHz to 2700 MHz)
- Internally matched for ease of use
- Integrated current sense
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

### 1.3 Applications

- RF power amplifiers for base stations and multi carrier applications in the 2500 MHz to 2700 MHz frequency range

## 2. Pinning information

Table 2. Pinning

| Pin  | Description                | Simplified outline | Graphic symbol |
|------|----------------------------|--------------------|----------------|
| 1    | drain                      |                    |                |
| 2    | gate                       |                    |                |
| 3    | source <a href="#">[1]</a> |                    |                |
| 4, 5 | sense drain                |                    |                |
| 6, 7 | sense gate                 |                    |                |

[1] Connected to flange.

## 3. Ordering information

Table 3. Ordering information

| Type number   | Package |  |          |
|---------------|---------|--|----------|
|               | Name    | Description  | Version  |
| BLF6G27L-50BN | -       | flanged ceramic package; 2 mounting holes; 6 leads | SOT1112A |

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol          | Parameter                 | Conditions | Min  | Max  | Unit |
|-----------------|---------------------------|------------|------|------|------|
| $V_{DS}$        | drain-source voltage      |            | -    | 65   | V    |
| $V_{GS}$        | gate-source voltage       |            | -0.5 | +13  | V    |
| $V_{GS(sense)}$ | sense gate-source voltage |            | -0.5 | +9   | V    |
| $T_{stg}$       | storage temperature       |            | -65  | +150 | °C   |
| $T_j$           | junction temperature      |            | -    | 200  | °C   |

## 5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol           | Parameter                                | Conditions   | Typ | Unit |
|------------------|--|--|-----|------|
| $R_{th(j-case)}$ | thermal resistance from junction to case | $T_{case} = 80\text{ °C}$ ; $P_L = 12.5\text{ W (CW)}$ | 1.3 | K/W  |

## 6. Characteristics

**Table 6. Characteristics**

$T_j = 25\text{ °C}$  per section; unless otherwise specified

| Symbol        | Parameter                        | Conditions   | Min | Typ  | Max | Unit          |
|---------------|----------------------------------|--|-----|------|-----|---------------|
| $V_{(BR)DSS}$ | drain-source breakdown voltage   | $V_{GS} = 0\text{ V}; I_D = 0.5\text{ mA}$   | 65  | -    | -   | V             |
| $V_{GS(th)}$  | gate-source threshold voltage    | $V_{DS} = 10\text{ V}; I_D = 72\text{ mA}$   | 1.4 | 1.9  | 2.4 | V             |
| $I_{Dq}$      | quiescent drain current          | sense transistor:<br>$I_{DS} = 9.1\text{ mA};$<br>$V_{DS} = 26.5\text{ V}$<br>main transistor:<br>$V_{DS} = 28\text{ V}$ | 380 | 430  | 480 | mA            |
| $I_{DSS}$     | drain leakage current            | $V_{GS} = 0\text{ V}; V_{DS} = 28\text{ V}$  | -   | -    | 1.5 | $\mu\text{A}$ |
| $I_{DSX}$     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75\text{ V};$<br>$V_{DS} = 10\text{ V}$   | 10  | 12   | -   | A             |
| $I_{GSS}$     | gate leakage current             | $V_{GS} = 11\text{ V}; V_{DS} = 0\text{ V}$  | -   | -    | 150 | nA            |
| $g_{fs}$      | forward transconductance         | $V_{DS} = 10\text{ V}; I_D = 3.6\text{ A}$   | -   | 5.0  | -   | S             |
| $R_{DS(on)}$  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75\text{ V};$<br>$I_D = 2.52\text{ A}$  | -   | 0.25 | -   | $\Omega$      |

## 7. Application information

**Table 7. 2-carrier W-CDMA application information**

All testing performed in Class-AB production test circuit; test signal 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz;  $f_1 = 2500\text{ MHz};$   $f_2 = 2600\text{ MHz};$   $f_3 = 2700\text{ MHz};$  RF performance at  $V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA}; T_{case} = 25\text{ °C};$  unless otherwise specified.

| Symbol   | Parameter                    | Conditions               | Min  | Typ  | Max | Unit |
|----------|------------------------------|--------------------------|------|------|-----|------|
| $G_p$    | power gain                   | $P_{L(AV)} = 3\text{ W}$ | 15.3 | 16.5 | -   | dB   |
| $\eta_D$ | drain efficiency             | $P_{L(AV)} = 3\text{ W}$ | 12.5 | 14.5 | -   | %    |
| ACPR     | adjacent channel power ratio | $P_{L(AV)} = 3\text{ W}$ | -    | -47  | -43 | dBc  |
| $I_{Dq}$ | quiescent drain current      | $V_{DD} = 28\text{ V}$   | -    | 430  | -   | mA   |

**Table 8. 1-carrier W-CDMA application information**

All testing performed in Class-AB production test circuit; test signal 3GPP; test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF per carrier;  $f = 2700\text{ MHz};$  RF performance at  $V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA}; T_{case} = 25\text{ °C};$  unless otherwise specified.

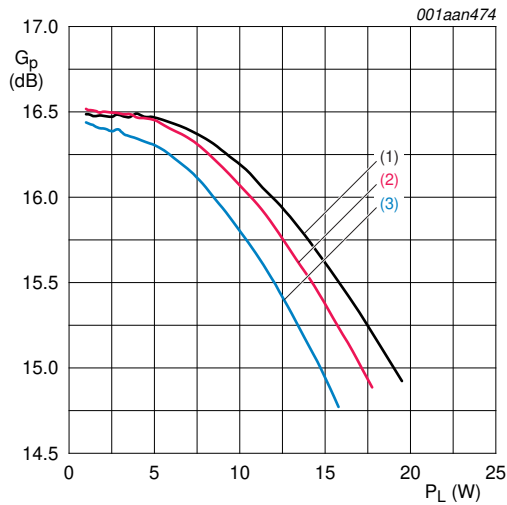
| Symbol  | Parameter                    | Conditions                | Min | Typ | Max | Unit |
|---------|------------------------------|---------------------------|-----|-----|-----|------|
| $PAR_O$ | output peak-to-average ratio | $P_{L(AV)} = 16\text{ W}$ | 4.1 | 4.7 | 5.3 | dB   |

### 7.1 Ruggedness in Class-AB operation

The BLF6G27L-50BN is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS} = 28\text{ V};$   $I_{Dq} = 430\text{ mA}; P_L = 40\text{ W (CW)};$   $f = 2500\text{ MHz}.$

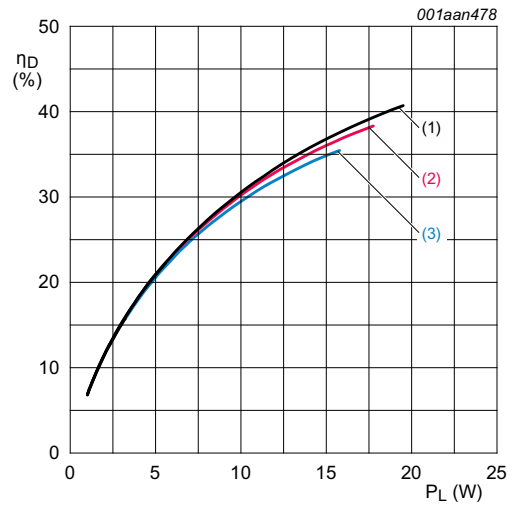
7.2 Single carrier IS-95

Single carrier IS-95 with pilot, paging, sync and 6 traffic channels (Walsh codes 8 - 13).  
 PAR = 9.7 dB at 0.01 % probability on the CCDF. Channel bandwidth is 1.2288 MHz.



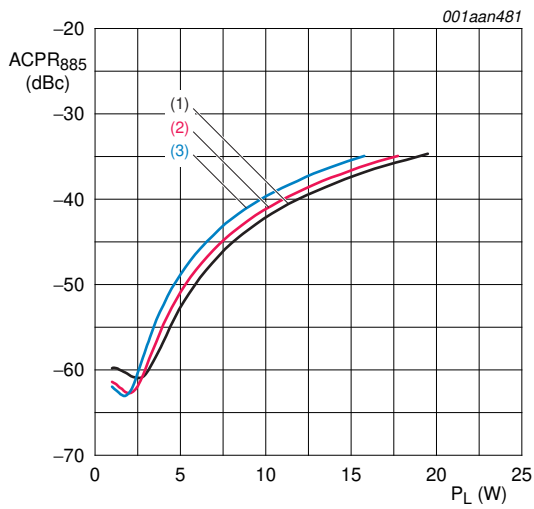
$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA}.$   
 (1)  $f = 2500\text{ MHz}$   
 (2)  $f = 2600\text{ MHz}$   
 (3)  $f = 2700\text{ MHz}$

Fig 1. Single carrier IS-95 power gain as a function of output power; typical values



$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA}.$   
 (1)  $f = 2500\text{ MHz}$   
 (2)  $f = 2600\text{ MHz}$   
 (3)  $f = 2700\text{ MHz}$

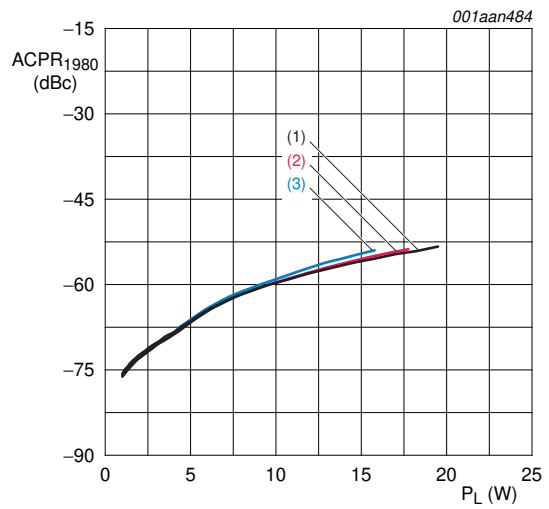
Fig 2. Single carrier IS-95 drain efficiency as a function of output power; typical values



$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA.}$

- (1)  $f = 2500\text{ MHz}$
- (2)  $f = 2600\text{ MHz}$
- (3)  $f = 2700\text{ MHz}$

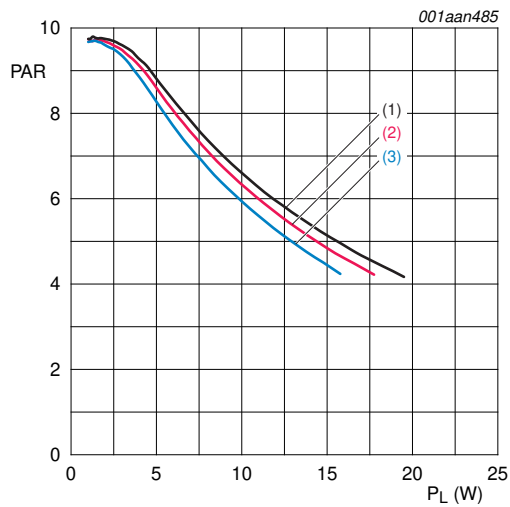
**Fig 3. Single carrier IS-95 ACPR at 885 kHz as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA.}$

- (1)  $f = 2500\text{ MHz}$
- (2)  $f = 2600\text{ MHz}$
- (3)  $f = 2700\text{ MHz}$

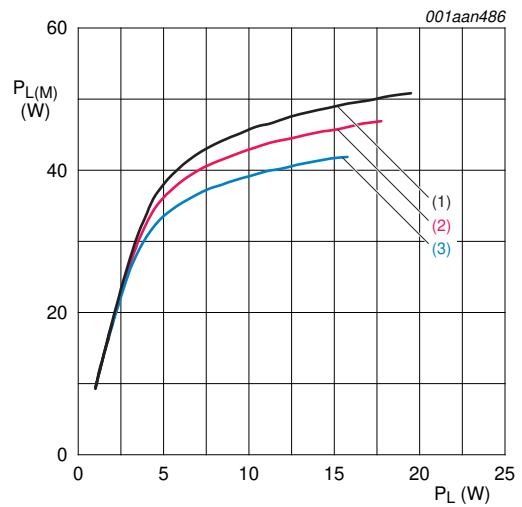
**Fig 4. Single carrier IS-95 ACPR at 1980 kHz as a function of output power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA.}$

- (1)  $f = 2500\text{ MHz}$
- (2)  $f = 2600\text{ MHz}$
- (3)  $f = 2700\text{ MHz}$

**Fig 5. Single carrier IS-95 peak-to-average power ratio as a function of output power; typical values**

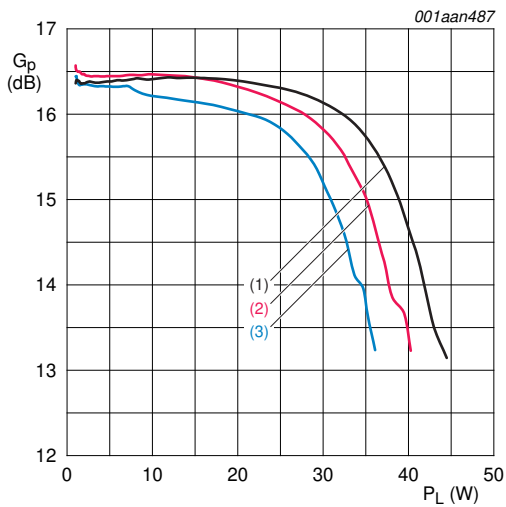


$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA.}$

- (1)  $f = 2500\text{ MHz}$
- (2)  $f = 2600\text{ MHz}$
- (3)  $f = 2700\text{ MHz}$

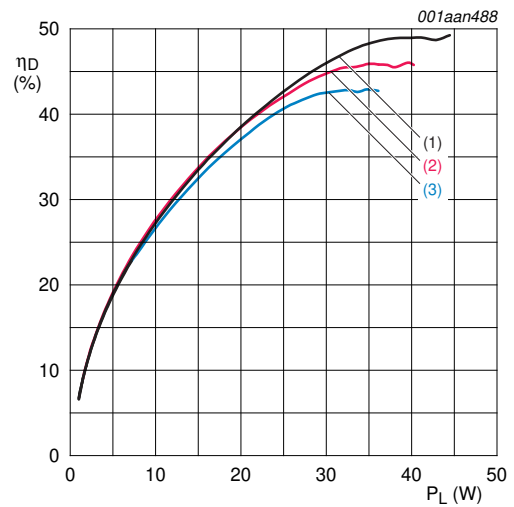
**Fig 6. Single carrier IS-95 peak power as a function of output power; typical values**

7.3 Pulsed CW



$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA}.$   
 (1)  $f = 2500\text{ MHz}$   
 (2)  $f = 2600\text{ MHz}$   
 (3)  $f = 2700\text{ MHz}$

**Fig 7. Pulsed CW power gain as a function of output power; typical values**

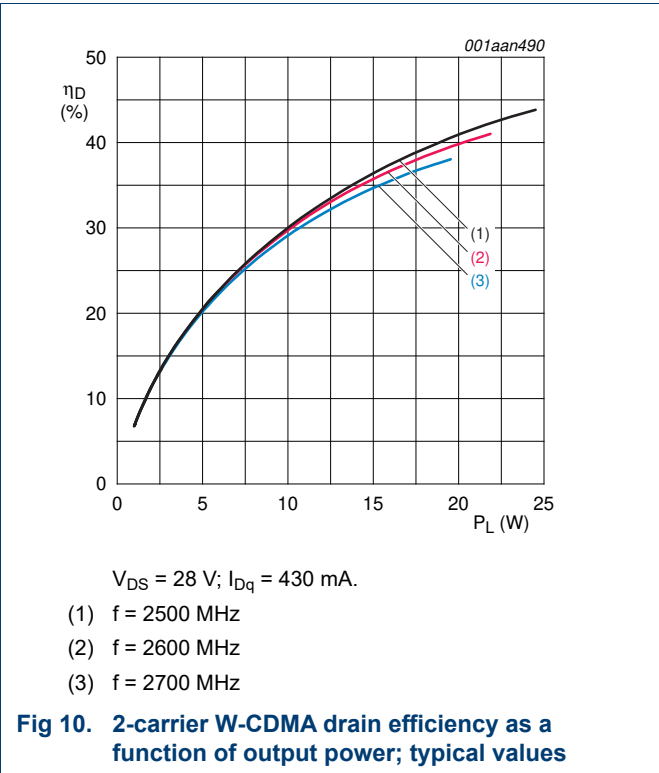
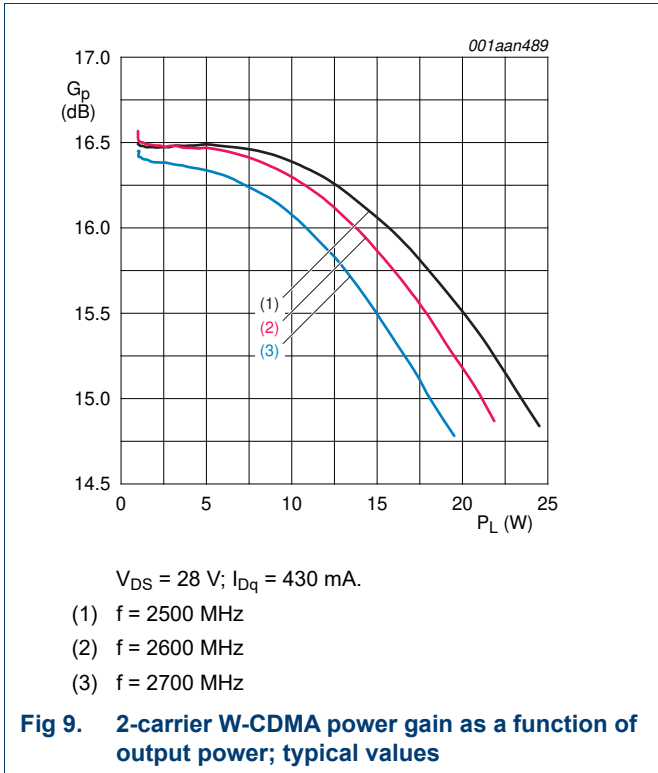


$V_{DS} = 28\text{ V}; I_{Dq} = 430\text{ mA}.$   
 (1)  $f = 2500\text{ MHz}$   
 (2)  $f = 2600\text{ MHz}$   
 (3)  $f = 2700\text{ MHz}$

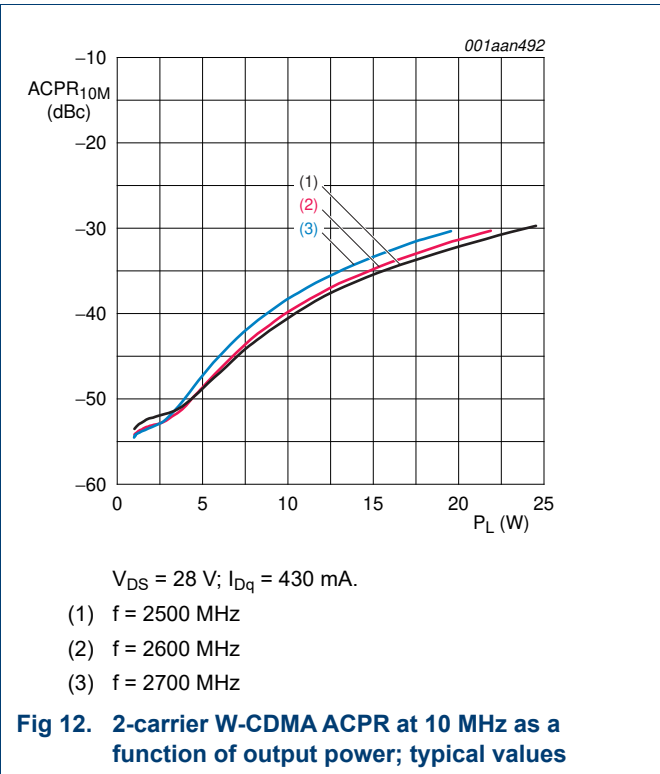
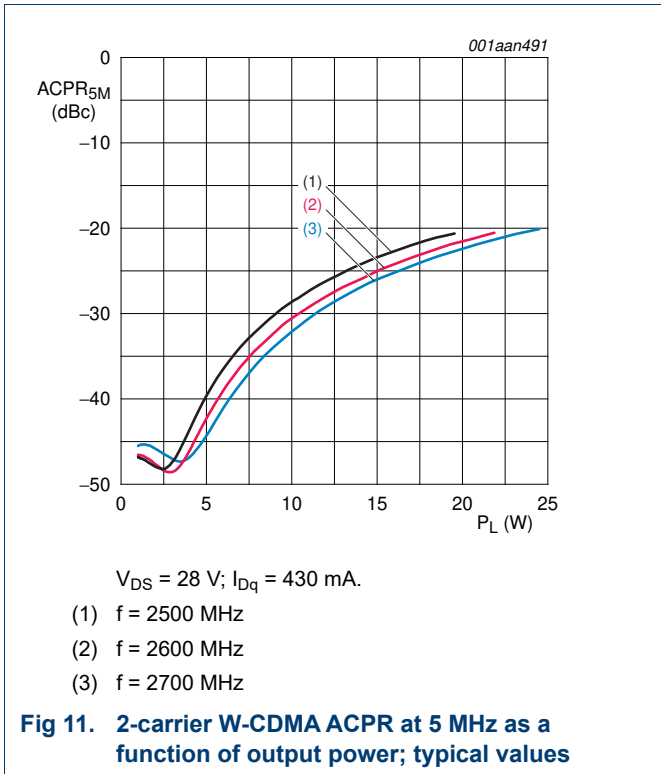
**Fig 8. Pulsed CW drain efficiency as a function of output power; typical values**

7.4 2-carrier W-CDMA

All testing performed in Class-AB production test circuit; test signal 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz;  $f_1 = 2500$  MHz;  $f_2 = 2600$  MHz;  $f_3 = 2700$  MHz;  $T_{case} = 25$  °C; unless otherwise specified.

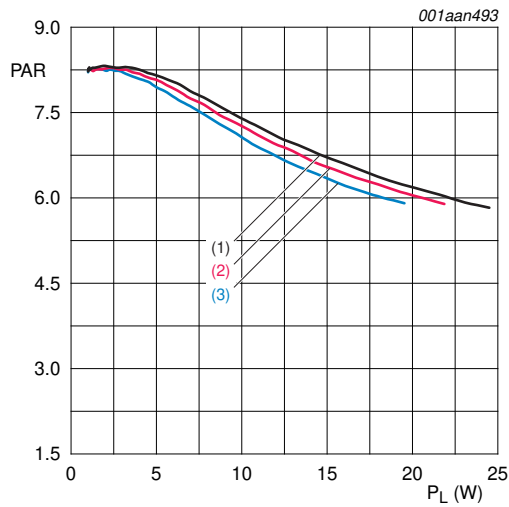






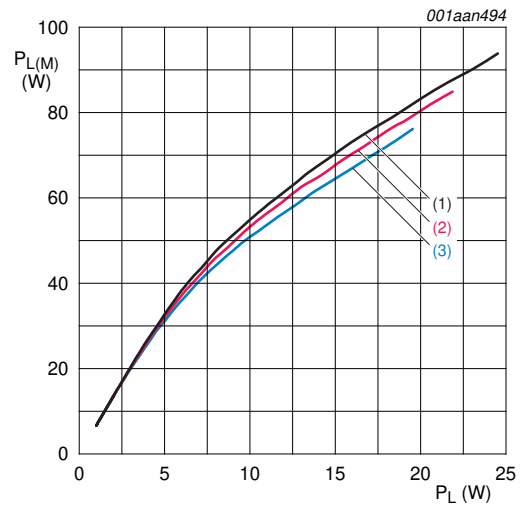
7.5 Single carrier W-CDMA

All testing performed in Class-AB production test circuit; test signal 3GPP; test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF per carrier; f = 2700 MHz; T<sub>case</sub> = 25 °C; unless otherwise specified.



V<sub>DS</sub> = 28 V; I<sub>Dq</sub> = 430 mA.  
 (1) f = 2500 MHz  
 (2) f = 2600 MHz  
 (3) f = 2700 MHz

Fig 13. Single carrier W-CDMA peak-to-average power ratio as a function of output power; typical values



V<sub>DS</sub> = 28 V; I<sub>Dq</sub> = 430 mA.  
 (1) f = 2500 MHz  
 (2) f = 2600 MHz  
 (3) f = 2700 MHz

Fig 14. Single carrier W-CDMA peak output power as a function of output power; typical values

8. Package outline

Flanged ceramic package; 2 mounting holes; 6 leads

SOT1112A

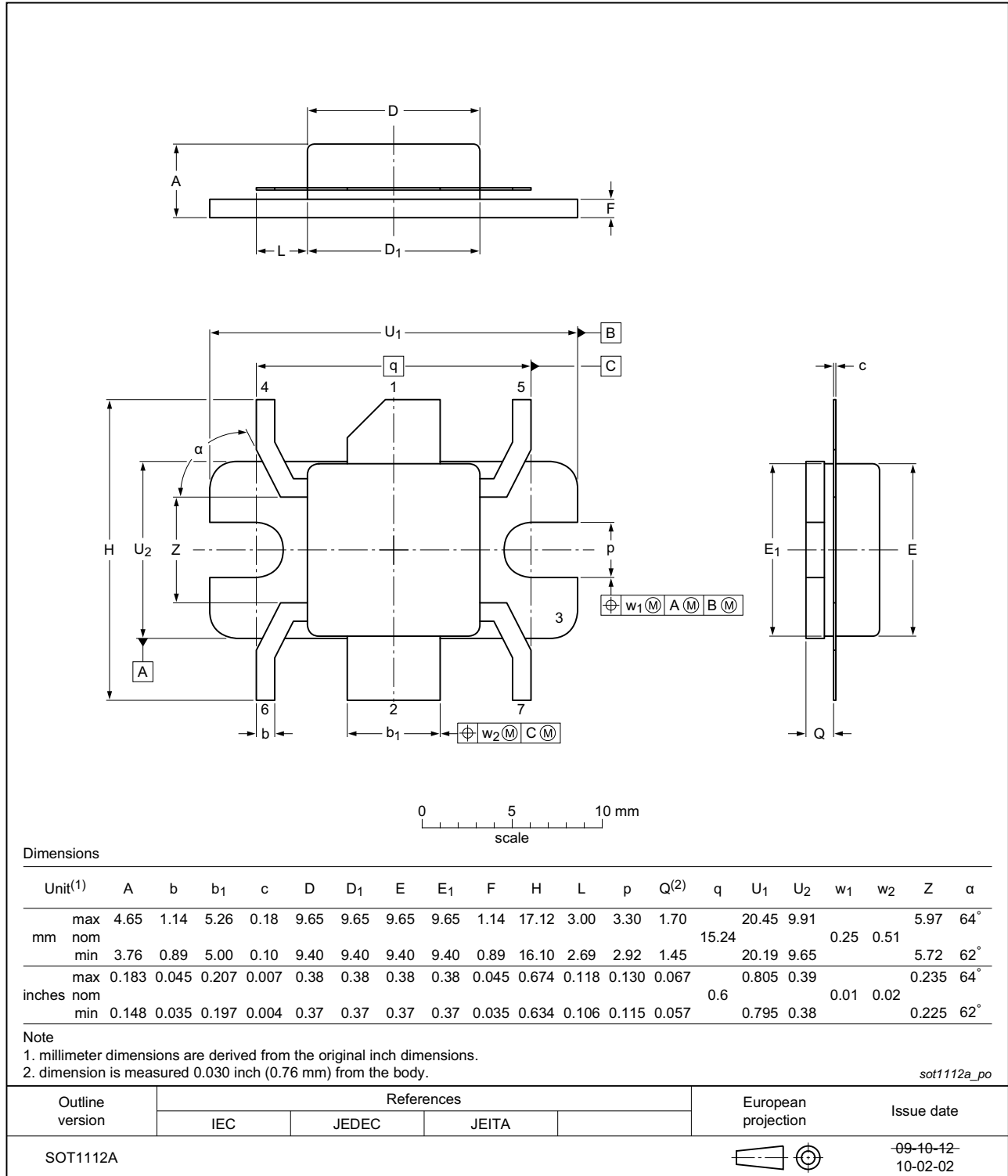


Fig 15. Package outline SOT1112A

## 9. Handling information

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

## 10. Abbreviations

Table 9. Abbreviations

| Acronym | Description                                    |
|---------|--|
| 3GPP    | 3rd Generation Partnership Project             |
| CCDF    | Complementary Cumulative Distribution Function |
| CW      | Continuous Wave                                |
| DPCH    | Dedicated Physical CHannel                     |
| ESD     | ElectroStatic Discharge                        |
| IS-95   | Interim Standard 95                            |
| LDMOS   | Laterally Diffused Metal-Oxide Semiconductor   |
| PAR     | Peak-to-Average Ratio                          |
| VSWR    | Voltage Standing-Wave Ratio                    |
| W-CDMA  | Wideband Code Division Multiple Access         |

## 11. Revision history

Table 10. Revision history

| Document ID                   | Release date   | Data sheet status    | Change notice | Supersedes                    |
|-------------------------------|--|----------------------|---------------|-------------------------------|
| BLF6G27L-50BN#4               | 20150901   | Product data sheet   | -             | BLF6G27L-50BN v.3             |
| Modifications:                | <ul style="list-style-type: none"> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                      |               |                               |
| BLF6G27L-50BN v.3             | 20141008   | Product data sheet   | -             | BLF6G27L-50BN_6G27LS-50BN v.2 |
| BLF6G27L-50BN_6G27LS-50BN v.2 | 20110407   | Product data sheet   | -             | BLF6G27L-50BN_6G27LS-50BN v.1 |
| BLF6G27L-50BN_6G27LS-50BN v.1 | 20100916   | Objective data sheet | -             | -                             |

## 12. Legal information

### 12.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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